Xianyang Yinghe Electronic Material Co. Ltd.

Glass Powder Catalogue

1

Address: No. 2 Jinhua Rd, Qindu District, Xianyang, Shaanxi , China

http://www.yhcailiao.com/

Founded in Jun. 2014 and located in the beautiful ancient city Xianyang Shaanxi, Xianyang Yinghe Electrnoic Material Co. Ltd. is a high-tech enterprise professionally manufactures low melting point glass which is widely used in electronic slurry(including conductive slurry, medium slurry, and resistor slurry), high temperature printing ink, automobile printing ink, toughened ink, solar energy silver slurry, aluminum slurry etc. many fields. The company has passed the authentication of ISO9001: 2015 Quality Assurance System and proudly obtained the AAA Grade Honored Unit issued by Quality Assurance Centre of Shaanxi Province. From dissolving to crushing to classification, with special fabrication method, it is produced under strict quality management system, which has been long trusted and admitted people in the field. Especially we provide much faster technical service to satisfy customers' various needs. The company holds professional, honest, cooperative and mutual-win concept, is willing to work together with person with insight to create a beautiful future.

App	ication	Main Purpose
Elelctronic	Conductive	silver slurry for electronic component, silver slurry for solar energy, aluminum slurry for solar
Slurry	Slurry	energy.
	Electronic	Ruthenium series electronic slurry, silver palladium resistor slurry, carbon film resistor slurry
	Resistance	
	slurry	
	medium slurry	chip resistor sealing medium slurry, stainless steel insulation medium slurry, other insulation
		and sealing medium slurry
High Tem	perature Printing	Automobile printing ink, Family electrical appliances printing ink, photovoltaic high reflection
Ink		printing ink

Glass Powder species	Glass Powder System	Softening Point °C	Expansion coeffcient (×10-6/°C)	Type of applied slurry	Application Field	Performance and Characteristics	Firing Temperature applied°C	If in accord with ROHS
GP2002	Bi3O3-SiO2-CuO-MnO2	687	9.5	Conductive slurry	Conductive silver slurry, silver palladium slurry for	Very good attaching force with aluminum oxide base, good resistance to acid	850±50	yes
GP2003	V2O5 -ZnO	526	6.4	Conductive slurry	thick film electric circuit	Very good attaching force with aluminum oxide base	850±50	yes
GP2005	Bi3O3-SiO2-CuO-MnO2-V2O5-ZnO	687	9.5	shirry	resistance back	Very good attaching force with aluminum oxide base, good resistance to acid	850±50	yes
GP2007	CaO-Al2O3-SiO2	550	6	Conductive slurry		Very good soldering resistance	850±50	yes
GP2009	CaO-Al2O3-SiO2	580	6.5	Conductive slurry	chip resistor face silver electrode	good resistance to acid, good soldering resistance	850±50	yes
GP2016	Bi2O3-B2O3-ZnO	450	7.8	Conductive	Ceramic capacitor,	Good attaching	750~800	yes

Glass Powder for Conductive Slurry

				slurry	slurry, NTC, PTC	force, Good electrical performance		
GP2018	Bi2O3-B2O3	420	8.2	Conductive slurry	and varistor	Good attaching force, Good electrical performance	550~600	yes
GP2019	Bi2O3-B2O3-ZnO	430	7.9	Conductive slurry		Good attaching force, Good electrical performance	550	yes
GP2022	V2O5 –ZnO-BaO	450	7.5		Solar energy back aluminum slurry	Good electrical performance	870	yes
GP2023	Bi3O3-PbO-SiO2-CuO-MnO2	630	9.8	Conductive slurry	Solar energy back silver slurry	Big pulling force , Good electrical performance	870	yes

Туре	L'omposition System	Softening point °C	Expansion Coefficient $(\times 10-6/^{\circ}C)$	Type of Applied Slurry	Application Field	Performance	Firing Temperature of application °C	If in accord with ROHS
GP3001	Bi2O3-B2O3-SiO2-R2O	480	7.2	Medium slurry	Chip resistor first time sealing medium slurry	Good resistant to acid, small change rate of sealing	600±5	Yes
GP3002	Bi2O3-B2O3-SiO2	470	8	Medium slurry	Sealing slurry of sealing protection for resistor net, thick film HIC	Good matching with resistor, aluminum oxide base	525±5	Yes
GP3006	CaO-Al2O3-SiO2	650	7.3	Medium slurry	On the base of stainless steel	Large expansion coefficient and good matching with stainless steel base	850±50	Yes
GP7002	B2O3-ZnO	598	5.4	Medium slurry	On the micro-crystal glass	Small expansion coefficient, good matching with base	650±10	Yes

Glass Powder for	High	temperature	Printing Ink
-------------------------	------	-------------	---------------------

Туре	Composition System	Softening point °C	Expansion Coefficient (×10-6/°C)	Type of Applied Slurry	Application Field	Performance	Firing Temperature of application °C	If in accord with ROHS
GP3015	Bi2O3-B2O3-SiO2-R2O	465	8.8	Automobile printing ink	Automobile front shield glass printing ink	Low firing temperature and good resistance to acid	530~560	Yes
GP3016	Bi2O3-B2O3-SiO2-ZnO-R2	478	9.7	Automobile printing ink	Automobile back shield glass printing ink	Good resistance to acid, Good concealment for silver paste	690-720	Yes
GP 3018	Bi2O3-B2O3-SiO2-R2O	495	8.5	Family Electrical Appliance Printing Ink	Family Electrical Appliance decoration printing ink	VERY Good resistance to acid	690-720	Yes
GP3020	Bi2O3-B2O3-SiO2-ZnO-R2	467	7.4	Family Electrical Appliance Printing Ink	Family Electrical Appliance decoration printing ink	Good color, good light avoidance, good performance for cold and hot impact and mechanics		Yes
GP3021	SiO2-B2O3-ZnO-R2O	474	9.5	Photovoltaic Printing Ink	Photovoltaic back plate high reflection printing ink	High reflection, good chemical stability	690-720	Yes

Туре	Composition System	Softening point °C	Expansion Coefficient (×10-6/°C)	Type of Applied Slurry	Application Field	Performance	Firing Temperature of application °C	If in accord with ROHS							
GP1001	PbO-B2O3-SiO2	538	6.7		_										
GP1002	PbO-B2O3-SiO2	519	5.9	Resistor Slurry	Ruthenium Series Resistor Slurry	4 1					Resistor Slurry	Resistor slurry for	Good matching performance with		
GP1005	PbO-B2O3-SiO2	541	6.4									Resistor Slurry	2	thick film circuit and	aluminum oxide base, good matching with
GP1007	PbO-B2O3-SiO2	607	5.9		chip resistor	ruthenium series phase									
GP2008	BaO –CaO-SiO2	750	8.4	Silver palladium resistance paste	Stainless steel heating device of Stainless steel	Small change rate of encapsulation	850±10	Yes							

Glass Powder for Resistor Slurry

Туре	Composition System	Softening point °C	Expansion Coefficient (×10-6/°C)	Type of Applied Slurry	Application Field		Firing Temperature of application °C	with ROHS	
GP4001	P2O5-ZnO-R2O	360	14	High					
GP4002	P2O5-ZnO-R2O	400	13	temperature	temperature	e metal	Good matching with metal	600°C	Yes
GP4003	P2O5-ZnO-R2O	570	9.0	coating					

Glass Powder for High Temperature